TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π-MOSV)

2SK3342

Switching Regulator and DC-DC Converter Applications Motor Drive Applications

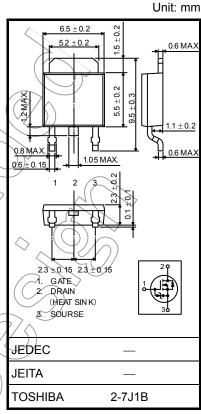
• Low drain-source ON resistance : $R_{DS\ (ON)} = 0.8\ \Omega\ (typ.)$ • High forward transfer admittance : $|Y_{fs}| = 4.5\ S\ (typ.)$

• Low leakage current : $I_{DSS} = 100 \mu A \text{ (max) (V}_{DS} = 250 \text{ V)}$

• Enhancement mode : $V_{th} = 1.5 \text{ to } 3.5 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA})$

Absolute Maximum Ratings (Ta = 25°C)

Characteris	tics	Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	250	(\sqrt{y})
Drain-gate voltage (RG	_{iS} = 20 kΩ)	V_{DGR}	250	V
Gate-source voltage		V_{GSS}	±20	V
Drain current	DC (Note 1)	ΙD	4.5	> A
Drain current	Pulse (Note 1)	I _{DP}	18	Α
Drain power dissipation	(Tc = 25°C)	P_{D}	20	W
Single pulse avalanche	energy (Note 2)	EAS	51	mJ
Avalanche current		IAR	4.5	A
Repetitive avalanche er	nergy (Note 3)	EAR	2.0	mJ
Channel temperature		((T _{ch}	150	∕\°C
Storage temperature ra	nge	T _{stg}	-55 to 150	~C



Weight: 0.36 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th} (ch-c)	6.25	°C/W
Thermal resistance, channel to ambient	Rth (ch-a)	125	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 50 V, T_{ch} = 25°C (initial), L = 4.28 mH, R_G = 25 Ω , I_{AR} = 4.5 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature This transistor is an electrostatic-sensitive device. Please handle with caution.

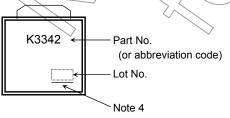
Electrical Characteristics (Ta = 25°C)

Charac	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μA
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = 250 V, V _{GS} = 0 V	_	_	100	μA
Drain-source br	eakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	250	_		V
Gate threshold v	/oltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	1.5	_	3.5	V
Drain-source O	N resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 2.5 A	(F	8.0(1.0	Ω
Forward transfer	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 2.5 A	2.0	4.5		S
Input capacitano	e	C _{iss}		\mathcal{D}	440		
Reverse transfe	r capacitance	C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	_	35	_	pF
Output capacita	nce	Coss		_	120	_	
Switching time	Rise time	tr	$V_{GS} = 10V$ $V_{GS} = 10V$ $V_{DD} = 100V$	_	15	<u> </u>	- ns
	Turn-on time	t _{on}		-	20	> _	
	Fall time	t _f		7	15	_	
	Turn-off time	t _{off}	Duty ≤1%, t _w =10μs	2)	60	_	
Total gate charg plus gate-drain)		Qg) _	10	ı	
Gate-source ch	arge	Q_{gs}	$V_{DD} \approx 200 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 4.5 \text{ A}$	_	6	-	nC
Gate-drain ("mil	ler") charge	Q _{gd}			4	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	IDR	(7/)-	_	_	4.5	Α
Pulse drain reverse current (Note 1)	I _{DRP}	-	_	_	18	Α
Forward voltage (diode)	V _{DSF}	T _{DR} = 4.5 A, V _{GS} = 0 V	_	_	-2.0	V
Reverse recovery time	t _{rr}	I _{DR} = 4.5 A, V _{GS} = 0 V,	-	110	_	ns
Reverse recovery charge	Qrr	dI _{DR} / dt = 100 A / μs	_	0.47	_	μC

Marking

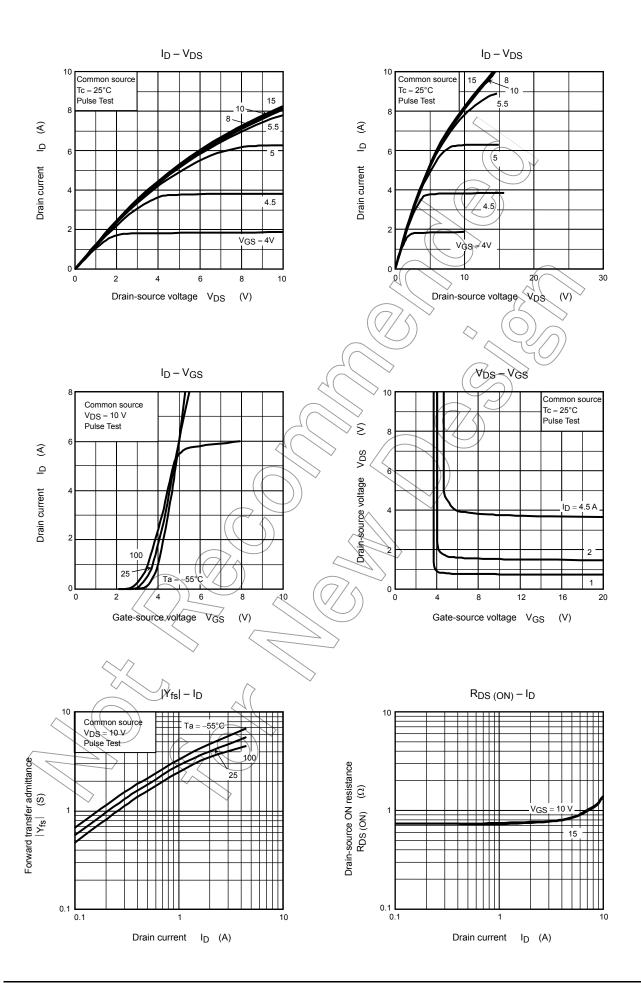


Note 4: A line under a Lot No. identifies the indication of product Labels.

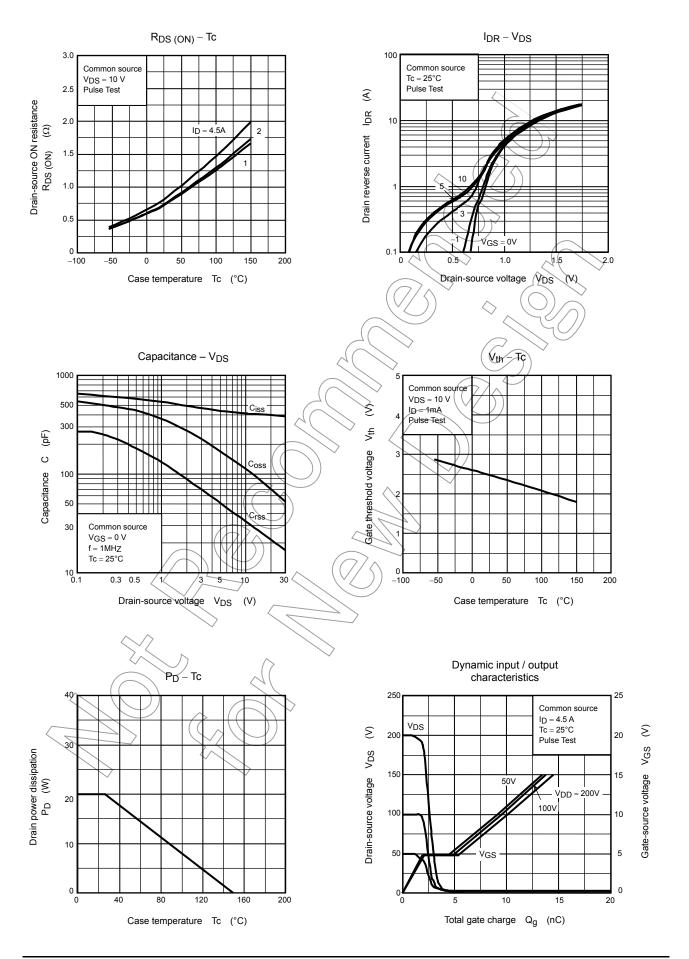
Not underlined: [[Pb]]/INCLUDES > MCV

 $\label{thm:compatible} \mbox{Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]}$

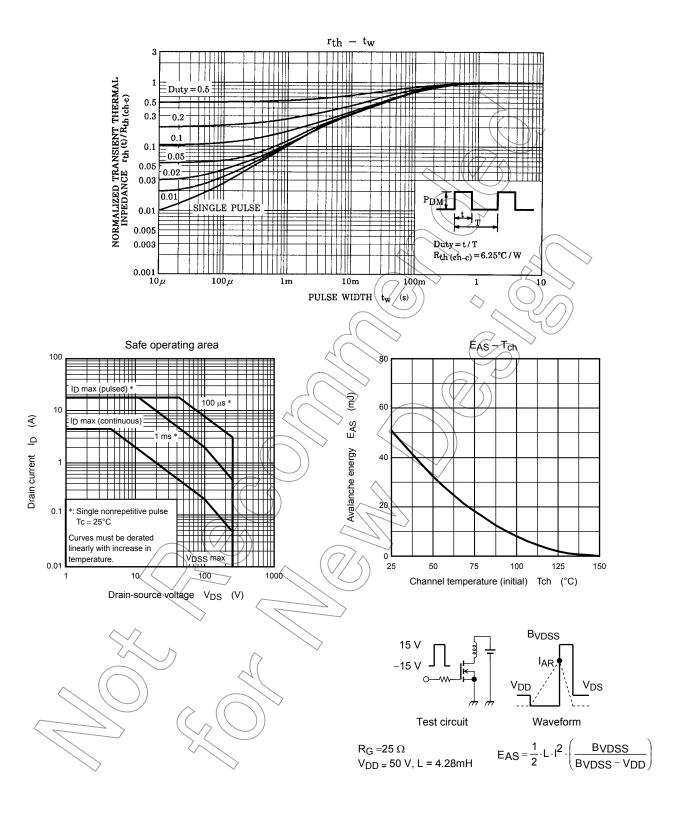
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